

Form No.: QF-1274

Edition: 2

ISO9001 ISO14001 IATF16949 CHILISIN ELECTRONICS CORP.

RoHS & Halogen Free & REACH Compliance.

SPECIFICATION FOR APPROVAL

Customer:		
Customer P/N :		
Drawing No:		
Quantity:	Pcs. Date	•:
Chilisin P/N:	BTLB0020123	G6H6A10
	SPECIFICATION ACCEPTED BY:	
COMPONENT ENGINEER		
ELECTRICAL ENGINEER		
MECHANICAL ENGINEER		
APPROVED		
REJECTED		
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奇力新電子(越南廠)存 Chilisin Electronics (Vietna No 143 - 145, Road No 10, Phong, Lap Le Commune, Dist, Haiphong City, Vietna Tel: 84-316 255 688 Fax E-mail: sales@chilisin.com	m) Limited HuNan Chilisin Electors VSIP Hai No. 8, Shaziao Lian County, Huaihua Ci China E 84-316 255 689 HuNan Chilisin Electors No. 8, Shaziao Lian County, Huaihua Ci China Tel : 86-745-867-58	etronics Technology Co., Ltd Igshuijing Town, Yuanling Ity, Hunan Province 419601, 1882
Drawn by YW	Checked by CF	Approved by Derek



APPLICATION

WLAN, Bluetooth, Home RF.

FEATURES

1-1 Compact Size

Miniaturized SMD packaged in low profile and lightweight.

1-2 Low loss

Low insertion loss, high attenuation.

1-3 High Soldering Heat Resistance

High quality termination allows both flow and re-flow soldering methods to be applied.

1-4 Characteristics

Eliminate noise over a wide frequency range. Idea for high frequency and space limited designs.

1-5 Internal Shielding incorporated

1-6 Available in tape and reel packaging for automatic mounting

PRODUCT IDENTIFICATION

<u>BTLB</u>	00	2012	<u>###xx</u>	<u>A 1</u>	0
(1)	(2)	(3)	(4)	(5)	6

- ① Product Code
- 2 Customer Code
- 3 Dimension Code
- Series Type (### represents center frequency and xx represents material type)
- ⑤ Design Code
- © Version Code

ELECTRICAL REQUIREMENTS

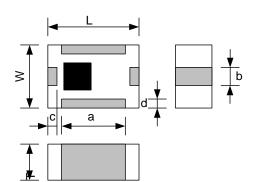
Part NO.	Pass Band	Insertion Loss in BW	VSWR In BW	Attenuation
BTLB0020123G6H6A10	3300~3900 MHz	1.8 dB max.	2 max.	15 dB min. at 100~2600 MHz 20 dB min. at 6000~9000 MHz

Operating Temperature Range: -40~85°C

Power Capacity: 3W max.



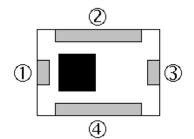
PRODUCT DIMENSION



L	W	Т	а
2.00±0.15	1.25±0.15	0.95±0.10	1.60+0.10 -0.15
b	С	d	
0.30+0.10 -0.15	0.30±0.20	0.30±0.20	

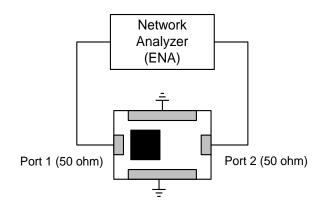
NOTE: Dimensions in mm

TERMINAL CONFIGURATION



- ① IN
- ② GND
- ③ OUT
- **4** GND

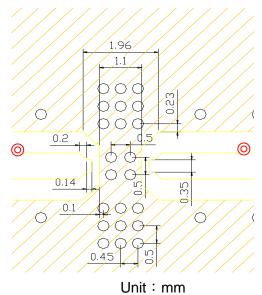
MEASURING DIAGRAM



Test Instrument:
Agilent E5071A Network Analyzer

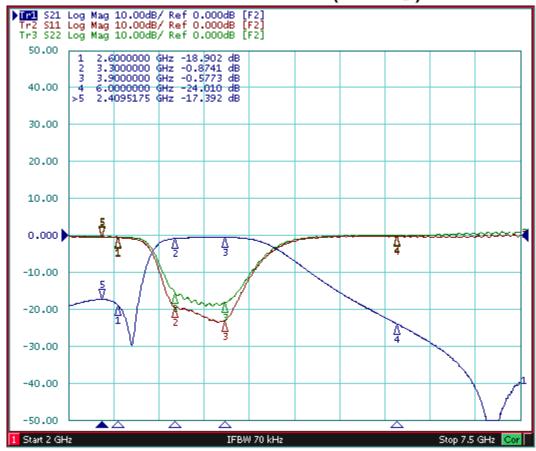


RECOMMENDED PCB LAYOUT



 \bigcirc Line width should be designed to match 50Ω characteristic impedance, depending on PCB material and thickness.

ELECTRICAL CHARACTERISTICS (T=25℃)





RELIABILITY TEST

Mechanical Test

Item	Test Condition	Specification
Vibration	10 Hz/min~55 Hz/min~10 Hz/min vibration frequency with 1.5 mm amplitude for two hours in x, y, z directions	No apparent damage
Drop shock	Dropped onto printed circuit board from 100cm height three times in x, y, z directions. The terminals shall be protected.	No apparent damage
Soldering heat resistance	Preheating temperature : 150±10°C Preheating time : 1 to 2 minutes Solder bath temperature : 260±5°C Bathing time : 5±0.5 seconds	No apparent damage
Bending test onto printed circuit board	Solder specimen LTCC components on the test printed circuit board (L: 100 x W: 40 x T: 1.6mm) in appended recommended PCB pattern. Apply the load in direction of the arrow until bending reaches 2 mm.	No apparent damage
Solderability	The dipped surface of the terminal shall be at least 75% covered with solder after dipped in solder bath of 245±5°C for 3±0.5 seconds.	No apparent damage

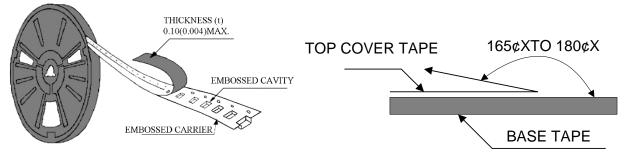
Environment Test

Thermal shock -40°C ~85°C for 100 cycles each cycle being 30 min		No apparent damage Fulfill the electrical spec. after test	
Humidity resistance	85±2°C, 80~90% R.H. for 500 hours	No apparent damage Fulfill the electrical spec. after test	
High temperature resistance 85±2°C for 500 hours		No apparent damage Fulfill the electrical spec. after test	
Low temperature resistance	-40±3°C for 500 hours	No apparent damage Fulfill the electrical spec. after test	



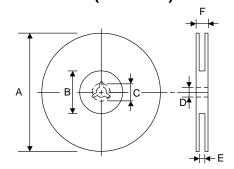
PACKAGING FOR SMC

Peel-off force



The force for peeling off cover tape is 10 grams in the arrow direction.

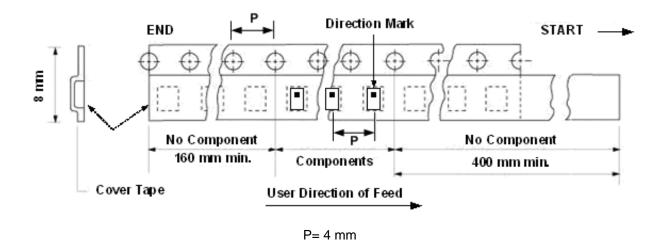
Dimension (Unit: mm)



TYPE	A	В	С	D	E	F
8 mm	178±1	60+0.5 -0	-	13±0.2	9±0.5	12±0.5
12 mm	178±0.3	60±0.2	19.3±0.1	13.5±0.1	13.6±0.1	-

Taping quantity

SERIES	5824 5724	5320 5220	4532	4516	3225	3216 2520	2012 1608 1109	1005
PCS/Reel	5000	3000	1000	2000	2500	3000	4000	10000





TAPE PACKING CASE

H

No. of Reels	W	L	Н
2	18±0.5	18±0.5	2.4±0.2
3	18±0.5	18±0.5	3.6±0.2
4	18±0.5	18±0.5	4.8±0.2
5	18±0.5	18±0.5	6.0±0.2

OPERATION TEMPERATURE

-40°C~85°C

STORAGE CONDITION

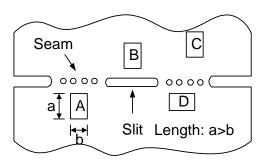
The temperature should be within -40~85°C and humidity should be less than 75% RH. The product should be used within 6 months from the time of delivery.

ATTENTION REGARDING PCB BENDING

(a) PCB shall be designed so that products are not subjected to the mechanical stress for board wrapage. Product shall be located in the sideway direction to the mechanical stress.

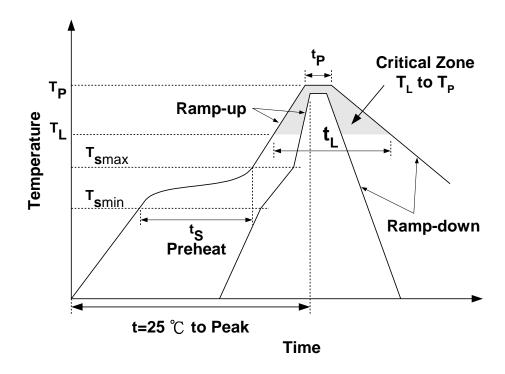


(b) Products (A,B,C,D) shall be located carefully so that products are not subjected to the mechanical stress due to warping the board. Because they may be subjected to the mechanical stress in order of A>C>B≒D.





RECOMMENDED REFLOW SOLDERING PROFILE



Profile Feature		Sn-Pb	Pb-Free
	ts	60~120 seconds	60~180 seconds
Preheat	T _{smin}	100℃	150℃
	T _{smax}	150℃	200℃
Average ramp-up rate (T _{smax} to T _P)		3°C/second max.	3°C/second max.
Time main above	Temperature (T∟)	183 ℃	217 ℃
	Time (t∟)	60~150 seconds	60~150 seconds
Peak temperature	(T _P)	230 ℃	250~260 °ℂ
Time within 5°C of actual peak temperature (t₂)		10 seconds	10 seconds
Ramp-down rate		6°C/sec max.	6°C/sec max.
Time 25°C to peak temperature		6 minutes max.	8 minutes max.

NOTES

The contents of this data sheet are subject to change without notice. Please confirm the specifications and delivery conditions when placing your order.

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MAPDCC0005 3A325 40287 ATB3225-75032NCT BD0810N50100AHF JHS-115-PIN DC0710J5005AHF DC2327J5005AHF 43020

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051157-0000 PD0922J5050D2HF 1E1305-3 1F1304-3S 1G1304-30 B0922J7575AHF 10017-3 TP-103-PIN BD1222J50200AHF

BD1722J50100AHF 2450DP39K5400E BD0810J50150AHF BD1722J50200AHF DSS-113-PIN DS-327-PIN MACP-008125-CK07F0 DS-329-PIN